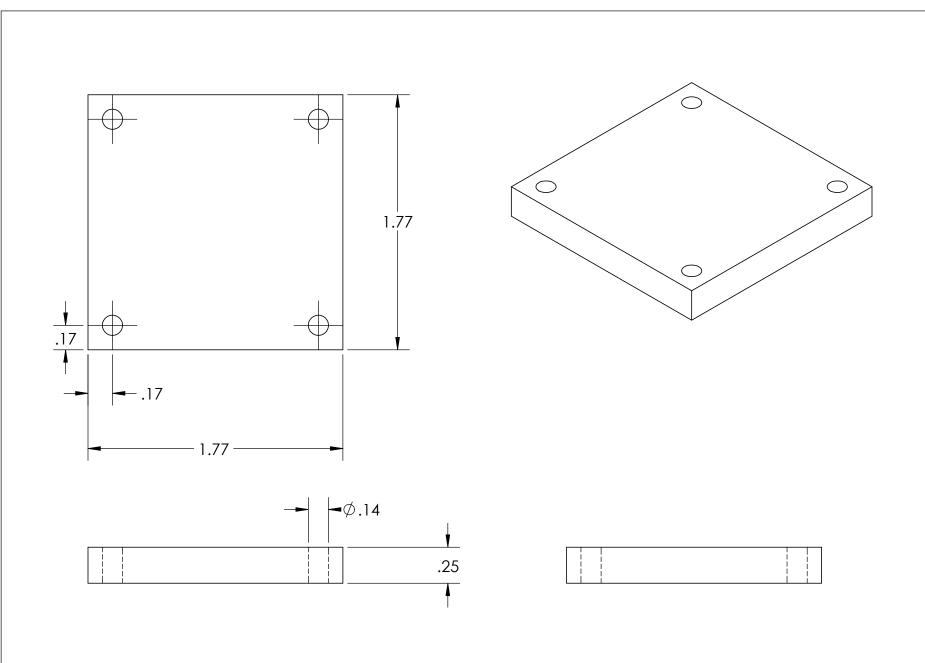
APP N05-3

Engineering 1282H Spring 2020

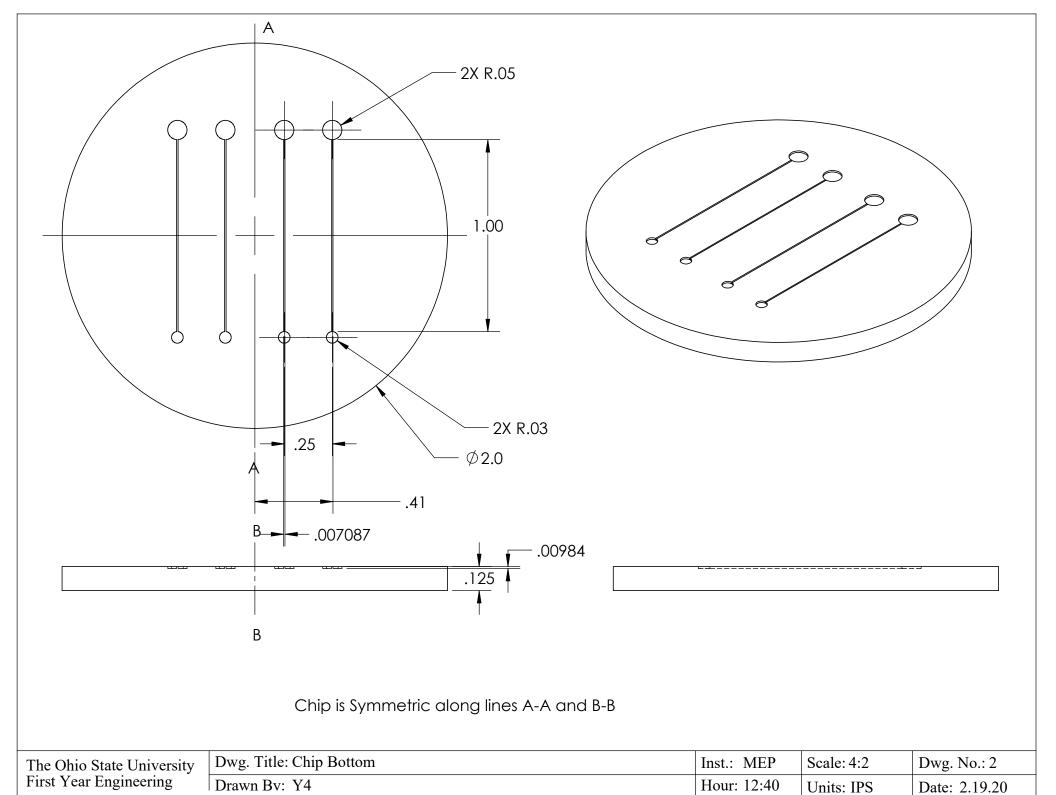
Team 4

Parke 12:40 PM

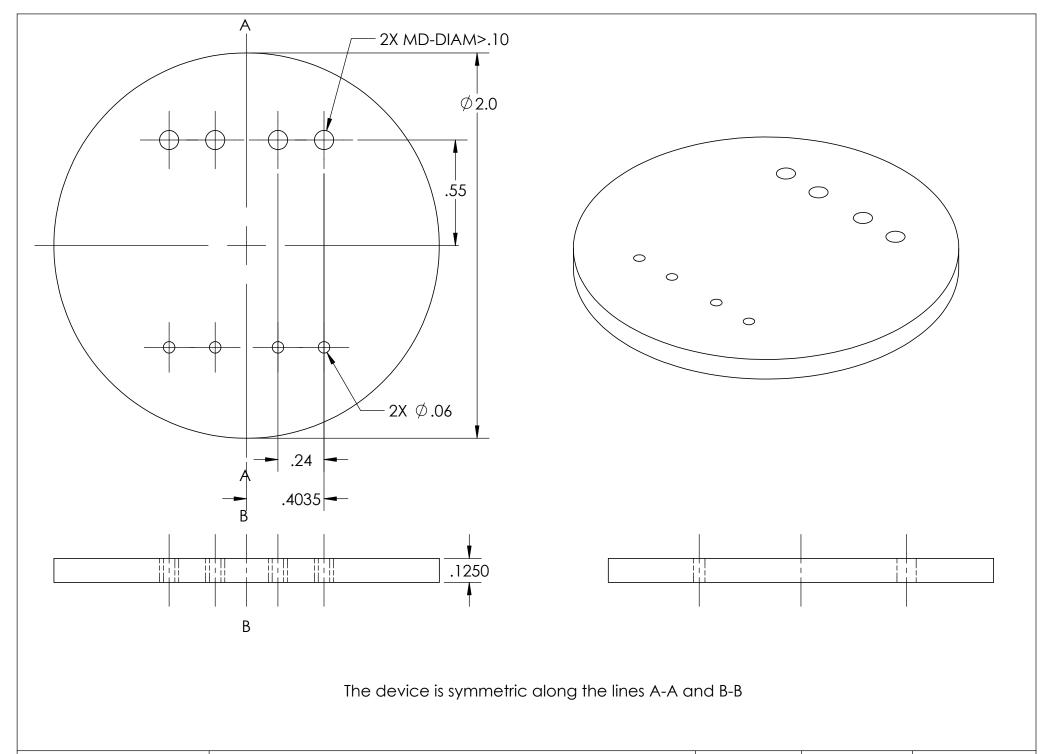
Date of Submission: 2/20/20



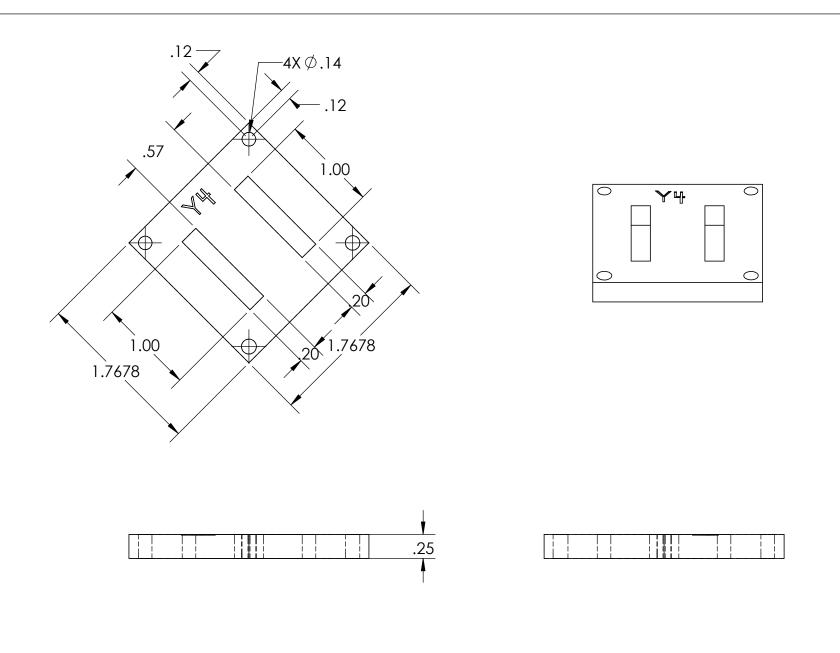
The Ohio State University First Year Engineering	Dwg. Title: Chip Holder Bottom	Inst.: Parke	Scale: 3:2	Dwg. No.: 1
	Drawn By: Team 4	Hour: 12:40	Units: INS	Date: 2/19/2020



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The Ohio State University First Year Engineering	Dwg. Title: Chip Top	Inst.: MEP	Scale: 4:2	Dwg. No.: 3
	Drawn Bv: Y4	Hour: 12:40	Units: IPS	Date: 2.19.20



The Ohio State University First Year Engineering	Dwg. Title: Chip_Holder_Top	Inst.: Parke	Scale: 1:1	Dwg. No.: 1
	Drawn Bv: Team Y4	Hour: 12:40	Units: IPS	Date: 2/19/20

